Process / Product Change Notification





Dear Customer,

Please find attached our INFINEON Technologies PCN:

Decommission of Newport, Wales wafer fab, as announced on May 5th 2015

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 07-September-2017.
- Infineon aligns with the widely-recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgment of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG Postal Address Headquarters: Am Campeon 1-12, D-85579 Neubiberg, Phone +49 (0)89 234-0 Chairman of the Supervisory Board: Wolfgang Mayrhuber Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck Registered Office: Neubiberg Commercial Register Amtsgericht München HRB 126492

Process / Product Change Notification

N° 1009-DISTI42-C4002348-Private



Decommission of Newport, Wales wafer fab, as announced on May 5th 2015						
Products affected:						
	See attached for affected parts.					
Detailed Change Information:						
Subject:	Add Vanguard as qualified wafer fab and Etrend as qualified wafer test site for Mosfet Gen 12.2					
Reason:	As part of a manufacturing consolidation plan announced in March 2015, Infineon indicated that it would be closing the Fab facility and transferring the production capability for certain parts to Silicon Foundry. For the avoidance of doubt, in order to retain necessary flexibility to ensure supply security, the supply of products during the transition period will include products from both the old and the new site(s).					
Description:	Decommission of Newport, Wales wafer fab, as announced on May 5th 2015					
	MOSFET Gen 12.2					
		OLD	NEW			
	Wafer Fab Location	Infineon Technologies Newport Limited	Vanguard International Semiconductor			
	Wafer Test Location	Infineon Technologies Newport Limited	ETREND Hightech Corp, Hsin-Chu, TW			
Product Identification:	Wafer fab origins will not be distinguished through the external part marking or shipping labels, however, based on the assembly lot code and marked on the device. IFX internal systems will be able to trace the site of the wafer lots used to produce the final product.					
► Impact of Change:	No changes to form, fit, or function. The package outline remains the same. Datasheet specifications will not be changed. The package bill of material and the location for assembly and final test will not change.					
Attachments:	1009-CUST90-C40023	348-AffectedParts.xlsx				
► Time Schedule:						
 Final qualification report: 	Available					
First samples available:	On request					
Intended start of delivery:	19-September-2017					

If you have any questions, please do not hesitate to contact your local Sales office.

PCN N° 1009-DISTI42-C4002348-Private

Cinfineon

Sales Name	SP number	OPN	Package
IRLHS6242TRPBF	SP001573008	IRLHS6242TRPBF	PQFN 2X2 6L
IRLHS6276TRPBF	SP001552670	IRLHS6276TRPBF	PG-TSDSON-6-900
IRLHS6342TRPBF	SP001573840	IRLHS6342TRPBF	PQFN 2X2 6L
IRLHS6376TRPBF	SP001573000	IRLHS6376TRPBF	PG-TSDSON-6-900
IRLH6224TRPBF	SP001558772	IRLH6224TRPBF	PG-TDSON-8-907
IRLML6244TRPBF	SP001558344	IRLML6244TRPBF	SOT23
IRLML6246TRPBF	SP001568932	IRLML6246TRPBF	SOT23
IRLML6344TRPBF	SP001574050	IRLML6344TRPBF	SOT23
IRLML6346TRPBF	SP001578770	IRLML6346TRPBF	SOT23
IRLR6225TRPBF	SP001573984	IRLR6225TRPBF	DPAK
IRLTS6342TRPBF	SP001578898	IRLTS6342TRPBF	TSOP6L